## General Description

The MIC2090 and MIC2091 are high-side MOSFET power switches optimized for general-purpose 50 mA or 100 mA low power distribution in circuits requiring over-current limiting and circuit protection. Typical applications for these parts are for switching power in USB ports, portable consumer items, camera and camcorder motor protection, thermal printer head protection, and many other low current-load switching applications.

The MIC2090 and MIC2091 come in two versions: autoretry current limit and output latch off on an over current fault. The MIC2090 and MIC2091 are offered in a space saving 5 -pin SOT-23 package with an operating junction temperature range of $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

## Features

- 1.8 V to 5.5 V supply voltage
- $790 \mathrm{~m} \Omega$ typical $\mathrm{R}_{\mathrm{DSON}}$ at 3.3 V
- MIC2090 is rated for 50 mA minimum continuous current
- MIC2091 is rated for 100 mA minimum continuous current
- Reverse current blocking (OGI)
- 20 ns super fast reaction time to hard short at output
- 10 ms fault flag delay ( $\mathrm{t}_{\text {_FAuLTI }}$ ) eliminates false assertions
- Auto-retry overcurrent and short-circuit protection (-1 version)
- Latch-off on current limit (-2 version)
- Thermal shutdown
- Fault status flag indicates: over-current, overtemperature, or UVLO
- Under-voltage lockout (UVLO)
- Low quiescent current


## Applications

- USB peripherals
- Camcorder
- DSC
- MP3/iPod
- SD protection
- USB low-power hub


## Typical Application



MIC2091 USB Power Switch


Startup into Short Circuit

Micrel Inc. • 2180 Fortune Drive •San Jose, CA 95131•USA•tel +1 (408) 944-0800• fax + 1 (408) 474-1000•http://www.micrel.com

## Ordering Information

| Part Number | Marking | Current <br> Limit | Current-Limit <br> Recovery | Junction Temperature <br> Range | Package |
| :--- | :---: | :---: | :---: | :---: | :---: |
| MIC2090-1YM5 | $\underline{\text { L1K }}$ | 50 mA | Auto-Retry | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SOT-23-5 |
| MIC2091-1YM5 | $\underline{\text { M1K }}$ | 100 mA | Auto-Retry | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SOT-23-5 |
| MIC2090-2YM5 | $\underline{\text { L2K }}$ | 50 mA | Latch-Off | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SOT-23-5 |
| MIC2091-2YM5 | $\underline{\text { M2K }}$ | 100 mA | Latch-Off | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SOT-23-5 |

## Pin Configuration



5-Pin SOT-23 (M5)

## Pin Description

| Pin Number | Pin Name | Pin Function |
| :---: | :---: | :--- |
| 1 | VIN | Supply (Input): +1.8 V to +5.5 V . Provides power to the output switch and the MIC2090/MIC2091 <br> internal control circuitry. |
| 2 | GND | Ground. |
| 3 | FN | Enable (Input): Active-high TTL compatible control input. A high signal turns on the internal <br> switch and supplies power to the load. This pin cannot be left floating. |
| 4 | Fault Status (Output): Open drain output. Can be connected to other open drain outputs. Must <br> be pulled high with an external resistor. <br> When EN=0, FAULT/ pin is high <br> When EN=1, a low on the FAULT/ pin indicates one or more of the following conditions: <br> 1. The part is in current limit and is turned off. <br> 2. The part is in thermal limit and is turned off. <br> 3. The part is in UVLO |  |
| 5 | VOUT | Switched Output (Output): The voltage on this pin is controlled by the internal switch. Connect <br> the load driven by the MIC2090/MIC2091 to this pin. |Absolute Maximum Ratings ${ }^{(1)}$Supply Voltage ( $\mathrm{V}_{\text {IN }}$ )................................... -0.3 V to +6.0 VOutput Voltage (VOut). ................................ -0.3 V to +6.0 VFAULT/ Pin Voltage ( $\mathrm{V}_{\text {FaULTI }}$ ) ...................... -0.3 V to +6.0 VFAULT/ Pin Current ( $\mathrm{I}_{\text {FAULT }}$ ) ...................................... 25 mAEN Pin Voltage ( $\mathrm{V}_{\mathrm{EN}}$ ).......................... -0.3 V to $\left(\mathrm{V}_{\text {IN }}+0.3 \mathrm{~V}\right)$

Power Dissipation ( $\mathrm{P}_{\mathrm{D}}$ ). Internally Limited
Maximum Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ )........................ $150^{\circ} \mathrm{C}$
Storage Temperature ( $\mathrm{T}_{\mathrm{s}}$ ) ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (soldering, 10s). ..... $260^{\circ} \mathrm{C}$
ESD HBM Rating ${ }^{(3)}$ ..... 3 kV
ESD MM Rating ${ }^{(3)}$ ..... 200V

## Operating Ratings ${ }^{(2)}$

Supply Voltage ( $\mathrm{V}_{\text {IN }}$ ) ..... +1.8 V to +5.5 V
Output Voltage (VOUT) ..... +1.8 V to +5.5 V
EN Pin Voltage ( $\mathrm{V}_{\mathrm{EN}}$ ). ..... 0 V to V In
FAULT/ Pin Voltage ( $\mathrm{V}_{\text {FAULT }}$ ) ..... 0 V to 5.5 V
FAULT/ Pin Current (I $\mathrm{I}_{\text {FAULTI }}$ ) ..... 1 mA
Ambient Temperature ( $\mathrm{T}_{\mathrm{A}}$ ) .....  $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) ..... $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Package Thermal ResistanceSOT23-5 ( $\theta_{\mathrm{JA}}$ )$252.7^{\circ} \mathrm{C} / \mathrm{W}$

## Electrical Characteristics ${ }^{(4)}$

$\mathrm{V}_{\mathrm{IN}}=5 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, bold values indicate $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$, unless noted.

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power Input Supply |  |  |  |  |  |  |
| VIN | Input Voltage Range |  | 1.8 |  | 5.5 | V |
| Ivin | Shutdown Current | $\mathrm{V}_{\text {EN }} \leq 0.5 \mathrm{~V}$ (switch off), $\mathrm{V}_{\text {OUT }}=$ open |  | 5 | 10 | $\mu \mathrm{A}$ |
|  | Supply Current | $\mathrm{V}_{\mathrm{EN}} \geq 1.5 \mathrm{~V}$ (switch on), $\mathrm{V}_{\text {OUT }}=$ open |  | 70 | 110 |  |
| Vuvio | Under-Voltage Lockout Threshold | $V_{\text {IN }}$ rising |  |  | 1.75 | V |
| Vuvlo_hys | Under-Voltage Lockout Threshold Hysteresis |  |  | 100 |  | mV |
| Enable Input |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{EN}}$ | Enable Logic Level High ${ }^{(5)}$ | $\mathrm{V}_{\mathrm{IH} \text { ( } \mathrm{MIN})}$ | 1.5 |  |  | V |
|  | Enable Logic Level Low ${ }^{(5)}$ | $\mathrm{V}_{\text {IL (MAX) }}$ |  |  | 0.5 |  |
| $\mathrm{I}_{\mathrm{EN}}$ | Enable Bias Current | $\mathrm{V}_{\text {EN }}=5 \mathrm{~V}$ |  | 0.1 |  | $\mu \mathrm{A}$ |
| ton | Output Turn-On Delay | $\mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{C}_{\mathrm{L}}=0.1 \mu \mathrm{~F}$ See "Timing Diagrams" |  | 215 |  | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{R}}$ | Output Turn-On Rise Time | $\mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{C}_{\mathrm{L}}=0.1 \mu \mathrm{~F}$ See "Timing Diagrams" |  | 5 |  | $\mu \mathrm{s}$ |
| toff | Output Turn-Off Delay | $\mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{C}_{\mathrm{L}}=0.1 \mu \mathrm{~F}$ See "Timing Diagrams" |  | 125 |  | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{F}}$ | Output Turn-Off Fall Time | $\mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{C}_{\mathrm{L}}=0.1 \mu \mathrm{~F}$ See "Timing Diagrams" |  | 115 |  | $\mu \mathrm{s}$ |
| Internal Switch |  |  |  |  |  |  |
| $\mathrm{R}_{\text {DSON }}$ | On Resistance $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ | MIC2090 $\mathrm{V}_{\text {IN }}=5.0 \mathrm{~V}$, lout $=50 \mathrm{~mA}$ |  | 700 | 1200 | $\mathrm{m} \Omega$ |
|  |  | MIC2090 $\mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}$, lout $=50 \mathrm{~mA}$ |  | 790 | 1200 |  |
|  |  | MIC2090 $\mathrm{V}_{\text {IN }}=1.8 \mathrm{~V}$, I lout $=50 \mathrm{~mA}$ |  | 1300 |  |  |
|  |  | MIC2091 $\mathrm{V}_{\text {IN }}=5.0 \mathrm{~V}$, lout $=100 \mathrm{~mA}$ |  | 700 | 1200 |  |
|  |  | MIC2091 $\mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}$, $\mathrm{l}_{\text {OUT }}=100 \mathrm{~mA}$ |  | 790 | 1200 |  |
|  |  | MIC2091 $\mathrm{V}_{\text {IN }}=1.8 \mathrm{~V}$, $\mathrm{l}_{\text {OUT }}=100 \mathrm{~mA}$ |  | 1300 |  |  |
|  | Input-to-Output Leakage Current (Forward leakage Current) | MIC2090 and MIC2091, $\mathrm{V}_{\mathrm{EN}} \leq 0.5 \mathrm{~V}$, (output off), $\mathrm{V}_{\text {IN }}=5.5 \mathrm{~V}$, $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ |  |  | 10 | $\mu \mathrm{A}$ |

## Electrical Characteristics ${ }^{(4)}$ (Continued)

$\mathrm{V}_{\mathrm{IN}}=5 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, bold values indicate $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$, unless noted.

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Output to Input Leakage Current (Reverse Leakage Current) | MIC2090 and MIC2091, $\mathrm{V}_{\mathrm{EN}} \leq 0.5 \mathrm{~V}$, (output off), $\mathrm{V}_{\text {OUT }}=5.5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0 \mathrm{~V}$ |  |  | 10 | $\mu \mathrm{A}$ |
| Current Limit |  |  |  |  |  |  |
| Ilimit | Current-Limit Threshold | MIC2090 @ V ${ }_{\text {OUt }}=4.5 \mathrm{~V}$ | 50 | 75 | 100 | mA |
|  |  | MIC2090 @ V ${ }_{\text {OUt }}=0 \mathrm{~V}$ | 50 | 100 | 150 |  |
|  |  | MIC2091 @ V ${ }_{\text {OUt }}=4.5 \mathrm{~V}$ | 100 | 150 | 200 |  |
|  |  | MIC2091 @ V ${ }_{\text {OUt }}=0 \mathrm{~V}$ | 100 | 175 | 250 |  |
| $t_{\text {SC_RESP }}$ | Short-Circuit Response Time | Short circuit applied to output after switch is turned on, see "Timing Diagrams". $\mathrm{V}_{\mathrm{IN}}=3.3 \mathrm{~V}$. |  | 20 |  | ns |
| $\mathrm{T}_{\text {AUTORESTART }}$ | Time After Switch Shuts Down From An OverCurrent Condition Before It Tries To Turn On Again. |  | 30 | 60 | 90 | ms |
| FAULT/ Flag |  |  |  |  |  |  |
|  | Error Flag Output Voltage | Output voltage high (1mA Sinking) |  |  | 0.4 | V |
| $t_{\text {D_FAULT/ }}$ | Time After Switch Comes Into Current Limit Before The PIN FAULT/ Is Pulled Low. | When an over-current condition happens, the part will go into constant output current for this time. After this time it will turn off the output and pull low the PIN FAULT/. The MIC2090-1 and MIC2091-1 will automatically restart themselves after the auto restart time TAutorestart. | 5 | 10 | 20 | ms |
| $t_{\text {R_faULT/ }}$ | FAULT/ Rising Time | FAULT/ is connected to $\mathrm{V}_{\mathrm{IN}}=5 \mathrm{~V}$ through $10 \mathrm{k} \Omega$ and 100 pF in parallel. See "Timing Diagrams" |  | 5 |  | $\mu \mathrm{s}$ |
| $t_{\text {F_FAULT/ }}$ | FAULT/ Falling Time |  |  | 1 |  | $\mu \mathrm{s}$ |
| Reverse Voltage Protection (OGI) |  |  |  |  |  |  |
| OGI | Output Voltage Greater Than Input Voltage (OGI) | If the output voltage is greater than the input voltage by this amount, the part will shut down. The enable pin must be recycled to reset. |  | 85 |  | mV |
| OGItime |  | Time that the output voltage can be greater than the input voltage before the chip is shut down. |  | 10 |  | ms |
| Thermal Protection |  |  |  |  |  |  |
| Tovertemp | Over-Temperature Shutdown | TJ Rising |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
|  |  | TJ Falling |  | 140 |  |  |

## Notes:

1. Exceeding the absolute maximum rating may damage the device.
2. The device is not guaranteed to function outside its operating rating.
3. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5 k in series with 100 pF .
4. Specification for packaged product only.
5. $\quad \mathrm{V}_{\mathrm{IL}(\mathrm{MAX})}=$ Maximum positive voltage applied to the input which will be accepted by the device as a logic low.
$\mathrm{V}_{\mathrm{IH}(\mathrm{MIN})}=$ Minimum positive voltage applied to the input which will be accepted by the device as a logic high.

## Timing Diagrams



Output Rise and Fall Times ( $\mathrm{t}_{\mathrm{R}}, \mathrm{t}_{\mathrm{F}}$ )


Switch Delay Time (ton,$t_{\text {OFF }}$ )

## Typical Characteristics



## Typical Characteristics (Continued)



OGI Threshold
vs. Input Voltage




OGI Delay
vs. Input Voltage


Enable Threshold
vs. Temperature


Output Fall Time vs. Input Voltage



Current Limit vs. Temperature (MIC2090)


## Typical Characteristics (Continued)





FAULT/ Delay vs. Temperature (MIC2090)


Current Limit vs. Temperature
(MIC2091)


Output Rise Time vs. Temperature


Auto-Reset Time vs. Temperature (MIC2090)

$\mathbf{R}_{\text {DS(ON) }}$
vs. Temperature


Output Turn-Off Delay vs. Temperature


## Typical Characteristics (Continued)






## Functional Characteristics



Time ( $200 \mathrm{~ms} / \mathrm{div}$ )


Enable Turn-On/Turn-Off


Enable Turn-Off Delay and Fall Time


## Functional Characteristics (Continued)

Current-Limit Response, Enabled into Short


Current-Limit Response, Stepped Short


Output Recovery from Short Circuit and FAULT/ Response (-1 Version)


Power-Up into Short Circuit (-1 Version)


Time ( $20 \mathrm{~ms} / \mathrm{div}$ )
Current-Limit Response, Stepped Overcurrent


Output Recovery from Thermal Shutdown and FAULT/ Response


Time ( $200 \mathrm{~ms} / \mathrm{div}$ )

## Functional Characteristics (Continued)



$\mathrm{V}_{\text {out }}>\mathrm{V}_{\text {IN }}$, Enable into Pre-Biased Output


$\mathrm{V}_{\text {OUT }}>\mathrm{V}_{\text {IN }}, \mathrm{V}_{\text {IN }}$ Turn-On into Pre-Biased Output


Time (10ms/div)

## Functional Characteristics (Continued)



Time ( $10 \mathrm{~ms} / \mathrm{div}$ )

## Overcurrent Lathch-Off and Recovery (-2 Version)



## Functional Diagram



MIC2090/MIC2091 Functional Diagram

## Functional Description

## $\mathrm{V}_{\text {IN }}$ and $\mathrm{V}_{\text {out }}$

$\mathrm{V}_{\text {IN }}$ is both the power supply connection for the internal circuitry driving the switch and the input (source connection) of the power MOSFET switch. Vout is the drain connection of the power MOSFET and supplies power to the load. In a typical circuit, current flows from $\mathrm{V}_{\text {IN }}$ to $\mathrm{V}_{\text {out }}$ toward the load.
When the switch is disabled, current will not flow to the load, except for a small unavoidable leakage current of a few microamps (forward leakage current).

## $\mathrm{C}_{\mathrm{IN}}$

A minimum $1 \mu \mathrm{~F}$ bypass capacitor positioned close to the $\mathrm{V}_{\mathrm{IN}}$ and GND pins of the switch is both good design practice and required for proper operation of the switch. This will control supply transients and ringing. Without a sufficient bypass capacitor, large current surges or a short may cause sufficient ringing on $\mathrm{V}_{\text {IN }}$ (from supply lead inductance) to cause erratic operation of the switch's control circuitry. For best performance, place a ceramic capacitor next to the IC.
An additional $10 \mu \mathrm{~F}$ (or greater) capacitor, positioned close to the VIN and GND pins of the switch is necessary if the distance between a larger bulk capacitor and the switch is greater than three inches. This additional capacitor limits input voltage transients at the switch caused by fast changing input currents that occur during a fault condition, such as current limit and thermal shutdown.
When bypassing with capacitors of $10 \mu \mathrm{~F}$ or more, it is good practice to place a smaller value capacitor in parallel with the larger to handle the high-frequency components of any line transients. Values in the range of $0.1 \mu \mathrm{~F}$ to $1 \mu \mathrm{~F}$ are recommended. Again, good quality, low-ESR capacitors, preferably ceramic, should be chosen.

## $\mathrm{C}_{\text {out }}$

An output capacitor is required to reduce ringing and voltage sag on the output during a transient condition. A value between $1 \mu \mathrm{~F}$ and $10 \mu \mathrm{~F}$ is recommended.
A $10 \mu \mathrm{~F}$ or larger capacitor should be used if the distance between the MIC2090/MIC2091 and the load is greater than three inches. The internal switch in the MIC2090/MIC2091 turns off in (typically) 20ns. This extremely fast turn-off can cause an inductive spike in the output voltage when the internal switch turns off during an overcurrent condition. The larger value capacitor prevents the output from glitching too low.

## Limitations on Cout $_{\text {out }}$

The part may enter current limit when turning on with a large output capacitance, which is an acceptable condition. However, if the part remains in current limit for a time greater than $t_{\text {D_FAuLt }}$, the FAULT/ pin will assert low. The maximum value of $\mathrm{C}_{\text {out }}$ may be approximated by Equation 1:

$$
\begin{equation*}
\mathrm{C}_{\text {OUT_MAX }}=\frac{\text { liMIT_MIN } \times \text { TD_FAULT_MIN }}{\mathrm{V}_{\text {IN_MAX }}} \tag{Eq. 1}
\end{equation*}
$$

Where: $\mathrm{I}_{\text {limit_min }}$ and $\mathrm{T}_{\text {D_fault_min } \text { are the minimum }}$ specified values listed in the Electrical Characteristic table and $\mathrm{V}_{\mathbb{I N}^{\prime} \max }$ is the maximum input voltage to the switch.

## Current Sensing and Limiting

The MIC2090/MIC2091 protects the system power supply and load from damage by continuously monitoring current through the on-chip power MOSFET. Load current is monitored by means of a current mirror in parallel with the power MOSFET switch. Current limiting is invoked when the load exceeds the overcurrent threshold. When current limiting is activated in the -1 version, the output current is constrained to the limit value, and remains at this level until either the load/fault is removed, the load's current requirement drops below the limiting value, or the switch goes into thermal shutdown. If the overcurrent fault is large enough to drop $\mathrm{V}_{\text {out }}$ below (typically) 1.8 V , the internal MOSFET turns off very quickly (typically 20ns). This prevents excessive current from flowing through the device and damaging the internal MOSFET.
The latch-off feature of the -2 version latches the output off when the output current exceeds the overcurrent threshold. $\mathrm{V}_{\mathbb{I N}}$ or the enable pin must be toggled to reset the latch.

## Enable Input

The EN pin is a TTL logic level compatible input which turns the internal MOSFET switch on and off. The FAULT/ pin remains high when the EN pin is pulled low and the output is turned off. Toggling the enable pin resets the output after an OGI (output greater than input) condition occurs. In the -2 version, toggling the enable pin resets the output after an overcurrent event.

## Fault Output

The FAULT/ is an N-channel open-drain output, which is asserted LOW when the MIC2090/MIC2091 switch either begins current limiting or enters thermal shutdown.

During an overcurrent or short circuit, The FAULT/ signal asserts after a brief delay period, $\mathrm{t}_{\mathrm{D}}$ FAuLt/, in order to filter out false or transient over-current conditions.
The FAULT/ output is open-drain and must be pulled HIGH with an external resistor. The FAULT/ signal may be wire-OR'd with other similar outputs, sharing a single pull-up resistor.

## Power Dissipation and Thermal Shutdown

Thermal shutdown is used to protect the MIC2090/MIC2091 switch from damage should the die temperature exceed a safe operating temperature. Thermal shutdown shuts off the output MOSFET and asserts the FAULT/ output if the die temperature reaches the over-temperature threshold, Tovertemp.
The switch will automatically resume operation when the die temperature cools down to $140^{\circ} \mathrm{C}$. If resumed operation results in reheating of the die, another shutdown cycle will occur and the switch will continue cycling between ON and OFF states until the reason for the overcurrent condition has been resolved.
Depending upon the PCB layout, package type, ambient temperature, etc., hundreds of milliseconds may elapse from the time a fault occurs to the time the output MOSFET will be shut off. This delay is caused because of the time it takes for the die to heat after the fault condition occurs.
Power dissipation depends on several factors such as the load, PCB layout, ambient temperature, and supply voltage. Calculation of power dissipation can be accomplished by Equation 2:

$$
\mathrm{P}_{\mathrm{D}}=\mathrm{R}_{\mathrm{DS}(\mathrm{ON})} \times\left(\mathrm{I}_{\mathrm{OUT}}\right)^{2}
$$

Eq. 2

To relate this to junction temperature, Equation 3 can be used:

$$
\begin{equation*}
T_{J}=P_{D} \times R_{\theta(J-A)}+T_{A} \tag{Eq. 3}
\end{equation*}
$$

Where:

$$
\begin{aligned}
& \mathrm{T}_{\mathrm{J}}=\text { Junction Temperature } \\
& \mathrm{T}_{\mathrm{A}}=\text { Ambient Temperature }
\end{aligned}
$$

$R_{\theta(J-A)}$ is the thermal resistance of the package.
In normal operation, excessive switch heating is most often caused by an output short circuit. If the output is shorted, when the switch is enabled, the MIC2090/MIC2091 switch limits the output current to the maximum value. The heat generated by the power dissipation of the switch continuously limiting the current
may exceed the package and PCB's ability to cool the device and the MIC2090/MIC2091 will shut down and signal a fault condition. Please see the "Fault Output" description for more details on the FAULT/ output.
After the MIC2090/MIC2091 shuts down, and cools, it will re-start itself if the enable signal remains true.
n Figure 2, die temperature is plotted against $\mathrm{l}_{\text {Out }}$ assuming a constant ambient temperature of $85^{\circ} \mathrm{C}$ and a worst case internal switch on-resistance ( $\mathrm{R}_{\mathrm{ON}}$ ). This plot is valid for both the MIC2090 and MIC2091.


Figure 2. Die Temperature vs. Iout

## $\mathrm{I}_{\text {LIMit }}$ vs. $\mathrm{I}_{\text {OUt }}$ Measured (-1 version only)

When the MIC2090/MIC2091 is current limiting, it is designed to act as a constant current source to the load. As the load tries to pull more than the maximum current, $V_{\text {out }}$ drops and the input to output voltage differential increases. When $\mathrm{V}_{\text {OUT }}$ drops below 1.8 V , then the output switch momentarily turns off to insure the internal MOSFET switch is not damaged by a very fast short circuit event.
When measuring lout in an overcurrent condition, it is important to remember voltage dependence, otherwise the measurement data may appear to indicate a problem when none really exists. This voltage dependence is illustrated in Figures 3 and 4.
In Figure 3, output current is measured as $\mathrm{V}_{\text {OUT }}$ is pulled below $\mathrm{V}_{\mathbb{I}}$, with the test terminating when $\mathrm{V}_{\text {OUT }}$ is 2.5 V below $\mathrm{V}_{\text {IN }}$. Observe that once $\mathrm{I}_{\text {LIMIT }}$ is reached $\mathrm{l}_{\text {out }}$ remains constant throughout the remainder of the test.
Figure 4 repeats this test but simulates operation deeper into an overcurrent condition. When $\mathrm{V}_{\text {Out }}$ drops below 1.8 V , the switch turns off for a few microseconds before turning back on.


Figure 3. lout in Current Limiting for $\mathrm{V}_{\text {out }}>\mathbf{1 . 8 V}$


Figure 4. Iout in Current Limiting for $\mathrm{V}_{\text {OUt }}<1.8 \mathrm{~V}$

## Under-Voltage Lock Out (UVLO)

The MIC2090/MIC2091 switches have an Under-Voltage Lock Out (UVLO) feature that will shut down the switch in a reproducible way when the input power supply voltage goes too low. The UVLO circuit disables the output until the supply voltage exceeds the UVLO threshold. Hysteresis in the UVLO circuit prevents noise and finite circuit impedance from causing chatter during turn-on and turn-off. While disable by the UVLO circuit, the output switch (power MOSFET) is OFF and no circuit functions, such as FAULT/ or EN, are considered to be valid or operative.

## OGI (Output Greater than Input)

The internal MOSFET switch turns off when it senses an output voltage that is greater than the input voltage. This feature prevents continuous current from flowing from the output to the input.
If the output voltage rises above $\mathrm{V}_{\mathrm{IN}}$ by the OGI threshold voltage (typically 85 mV ), the internal MOSFET switch turns off after a period of time, specified in the electrical characteristics table as $\mathrm{OGI}_{\text {time }}$. The FAULT/ pin remains high during and after an OGI event.
Figure 5 shows the output voltage, input current and FAULT/ pin voltage when the output voltage is raised above the input. Reverse current flows through the internal MOSFET switch for the OGI time period, until the internal MOSFET switch is turned off and the input current goes to 0 A .


Figure 5. OGI Event

## MIC2090/MIC2091 Evaluation Board Schematic



## Bill of Materials

| Item | Part Number | Manufacturer | Description | Qty. |
| :--- | :--- | :--- | :--- | :---: |
| C1, C2 | $08056 \mathrm{D} 106 \mathrm{MAT2A}$ | AVX $^{(1)}$ | $10 \mu \mathrm{~F}, 6.3 \mathrm{~V}$ Ceramic Capacitor, X5R | 2 |
| C3, C4 |  |  | NF (No Fill) | 2 |
| R1, R3 | CRCW06031002FRT1 | Vishay Dale $^{(2)}$ | $10 \mathrm{k}, 1 \%, 0603$ Resistor | 2 |
| R2 |  |  | NF (No Fill) | 1 |
| U1 | MIC2090-1YM5 | Micrel, Inc. $^{(3)}$ | Current Limiting Power Distribution Switch | $\mathbf{1}$ |
| U1 | MIC2091-1YM5 | Micrel, Inc. $^{(3)}$ | Current Limiting Power Distribution Switch | $\mathbf{0}$ |
| U1 | MIC2090-2YM5 | Micrel, Inc. $^{(3)}$ | Current Limiting Power Distribution Switch | $\mathbf{0}$ |
| U1 | MIC2091-2YM5 | Micrel, Inc. $^{(3)}$ | Current Limiting Power Distribution Switch | $\mathbf{0}$ |

Notes:

1. AVX: www.avx.com.
2. Vishay Tel: www.vishay.com.
3. Micrel, Inc.: www.micrel.com.

## PCB Layout Recommendations



Top Silk Screen


Top Copper

## PCB Layout Recommendations (Continued)



Bottom Copper


Bottom Silk Screen

## Package Information



5-Pin SOT23 (SOT23-5)

## Recommended Landing Pattern

ALL UNITS IN mm
TOLERANCE $\pm 0.05$ IF NOT NOTED


## MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA <br> TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB http://www.micrel.com

Micrel makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Micrel does not assume responsibility for its use. Micrel reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Micrel's terms and conditions of sale for such products, Micrel assumes no liability whatsoever, and Micrel disclaims any express or implied warranty relating to the sale and/or use of Micrel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.
© 2011 Micrel, Incorporated.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Power Switch ICs - Power Distribution category:
Click to view products by Microchip manufacturer:

Other Similar products are found below :
AP22652AW6-7 MAPDCC0001 L9349TR-LF MAPDCC0005 NCP45520IMNTWG-L VND5050K-E MP6205DD-LF-P FPF1018 DS1222 NCV380HMUAJAATBG TCK2065G,LF SZNCP3712ASNT3G L9781TR NCP45520IMNTWG-H MC17XS6500BEK SP2526A-1EN-L/TR SP2526A-2EN-L/TR MAX4999ETJ+T MC22XS4200BEK L9347LF-TR MAX14575BETA+T VN1160C-1-E VN750PEP-E TLE7244SL L9352B-TR-LF BTS50060-1EGA MAX1693HEUB+T MC07XSG517EK TLE7237SL MIC2033-05BYMT-T5 MIC2033-12AYMT-T5 MIC2033-05BYM6-T5 MP6513GJ-P NCP3902FCCTBG AP22811BW5-7 SLG5NT1437VTR SZNCP3712ASNT1G NCV330MUTBG DML1008LDS-7 MAX4987AEETA+T KTS1670EDA-TR MAX1694EUB+T KTS1640QGDV-TR KTS1641QGDV-TR IPS160HTR $\underline{\text { BTS500251TADATMA2 MC07XS6517BEKR2 SIP43101DQ-T1-E3 MAX1922ESA+C71073 MP6231DH-LF-Z }}$

